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Preface

NOTICE TO CUSTOMERS

All documentation becomes dated, and this manual is no exception. Microchip tools and documentation are constantly evolving to meet customer needs, so some actual dialogs and/or tool descriptions may differ from those in this document. Please refer to our web site (www.microchip.com) to obtain the latest documentation available.

Documents are identified with a "DS" number. This number is located on the bottom of each page, in front of the page number. The numbering convention for the DS number is "DSXXXXA", where "XXXXX" is the document number and "A" is the revision level of the document.

For the most up-to-date information on development tools, see the MPLAB IDE on-line help. Select the Help menu, and then Topics to open a list of available on-line help files.

INTRODUCTION

This chapter contains general information that will be useful to know before using the MCP6S2X Evaluation Board (Rev. 4). Items discussed in this chapter include:

- About This Guide
- · Warranty Registration
- Recommended Reading
- Troubleshooting
- The Microchip Web Site
- · Development Systems Customer Change Notification Service
- Customer Support

ABOUT THIS GUIDE

Document Layout

This document describes how to use MCP6S2X Evaluation Board (Rev. 4) as a development tool to emulate and debug firmware on a target board. The manual layout is as follows:

- Chapter 1: MCP6S2X Evaluation Board (Rev. 4) this section describes how to use the various features of the MCP6S2X Evaluation Board (Rev. 4).
- **Appendix A: Schematic** shows the schematic and printed circuit board (PCB) layout diagrams for the MCP6S2X Evaluation Board (Rev. 4).
- Appendix B: Bill of Materials (BOM) shows the parts used to build the MCP6S2X Evaluation Board (Rev. 4).
- **Appendix C: Evaluation Board Firmware** shows the firmware for the PIC16C505 source code used on the MCP6S2X Evaluation Board (Rev. 4).
- **Appendix D: Setup Conditions** shows configuration tables for the DIP switch settings and connections used for the MCP6S2X Evaluation Board (Rev. 4).

Conventions Used in this Guide

This manual uses the following documentation conventions:

DOCUMENTATION CONVENTIONS

Description	Represents	Examples	
Arial font:			
Italic characters	Referenced books	MPLAB IDE User's Guide	
	Emphasized text	is the only compiler	
Initial caps	A window	the Output window	
	A dialog	the Settings dialog	
	A menu selection	select Enable Programmer	
Quotes	A field name in a window or dialog	"Save project before build"	
Underlined, italic text with right angle bracket	A menu path	<u>File>Save</u>	
Bold characters	A dialog button	Click OK	
	A tab	Click the Power tab	
ʻbnnnn	A binary number where <i>n</i> is a digit	ʻb00100, ʻb10	
Text in angle brackets < >	A key on the keyboard	Press <enter>, <f1></f1></enter>	
Courier font:			
Plain Courier	Sample source code	#define START	
	Filenames	autoexec.bat	
	File paths	c:\mcc18\h	
	Keywords	_asm, _endasm, static	
	Command-line options	-Opa+, -Opa-	
	Bit values	0, 1	
Italic Courier	A variable argument	<i>file.o</i> , where <i>file</i> can be any valid filename	
0xnnnn	A hexadecimal number where <i>n</i> is a hexadecimal digit	0xFFFF, 0x007A	
Square brackets []	Optional arguments	<pre>mcc18 [options] file [options]</pre>	
Curly brackets and pipe character: { }	Choice of mutually exclusive arguments; an OR selection	errorlevel {0 1}	
Ellipses	Replaces repeated text	<pre>var_name [, var_name]</pre>	
	Represents code supplied by user	void main (void) { }	

RECOMMENDED READING

This user's guide describes how to use MCP6S2X Evaluation Board (Rev. 4). Other useful documents are listed below. The following Microchip documents are available and recommended as supplemental reference resources.

MCP6S2X PGA Data Sheet (DS21117)

This data sheet provides detailed information regarding the MCP6S21/2/6/8 family of PGAs.

THE MICROCHIP WEB SITE

Microchip provides online support via our WWW site at www.microchip.com. This web site is used as a means to make files and information easily available to customers. Accessible by using your favorite Internet browser, the web site contains the following information:

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- General Technical Support Frequently Asked Questions (FAQ), technical support requests, online discussion groups, Microchip consultant program member listing
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The Development Systems product group categories are:

- Compilers The latest information on Microchip C compilers and other language tools. These include the MPLAB C17, MPLAB C18 and MPLAB C30 C compilers; MPASM[™] and MPLAB ASM30 assemblers; MPLINK[™] and MPLAB LINK30 object linkers; and MPLIB[™] and MPLAB LIB30 object librarians.
- **Emulators** The latest information on Microchip in-circuit emulators. This includes the MPLAB ICE 2000 and MPLAB ICE 4000.
- In-Circuit Debuggers The latest information on the Microchip in-circuit debugger, MPLAB ICD 2.
- **MPLAB IDE** The latest information on Microchip MPLAB IDE, the Windows[®] Integrated Development Environment for development systems tools. This list is focused on the MPLAB IDE, MPLAB SIM and MPLAB SIM30 simulators, MPLAB IDE Project Manager and general editing and debugging features.
- Programmers The latest information on Microchip programmers. These include the MPLAB PM3 and PRO MATE[®] II device programmers and the PICSTART[®] Plus development programmer.

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Users of Microchip products can receive assistance through several channels:

- Distributor or Representative
- Local Sales Office
- Field Application Engineer (FAE)
- Technical Support
- · Development Systems Information Line

Customers should contact their distributor, representative or field application engineer (FAE) for support. Local sales offices are also available to help customers. A listing of sales offices and locations is included in the back of this document.

Technical support is available through the web site at: http://support.microchip.com

In addition, there is a Development Systems Information Line which lists the latest versions of Microchip's development systems software products. This line also provides information on how customers can receive currently available upgrade kits.

The Development Systems Information Line numbers are:

1-800-755-2345 - United States and most of Canada

1-480-792-7302 - Other International Locations

NOTES:



Chapter 1. MCP6S2X Evaluation Board (Rev. 4)

1.1 INTRODUCTION

The MCP6S21/2/6/8 family of Programmable Gain Amplifiers (PGA) is available with one, two, six or eight signal input channels, respectively. The user can digitally select a specific input channel and set the gain. This family of PGAs can be evaluated using the MCP6S2X Evaluation Board (Rev. 4). The evaluation board schematic is shown in Figure 1-1. This board uses the MCP6S21 and MCP6S26 to allow the user to connect two signal sources to evaluate the PGAs. The 10 k Ω pull-up resistors provide noise immunity for the PGA digital input pins.





MCP6S2X Evaluation Board (Rev. 4) simplified schematic.

1.2 EVALUATION BOARD DESCRIPTION

The single-channel MCP6S21 and six-channel MCP6S26 have been selected for this evaluation board. The PIC16F676 microcontroller is used to program the PGAs according to the user inputs. User inputs are selected using the on-board DIP switch settings that are configured according to the table printed on the evaluation board. This allows the user to program the channel, gain and shutdown of each PGA. Either PGA or both PGAs can be shut down. The six channels of the MCP6S26 and the PGA gains of 1, 2, 4, 5, 8, 10, 16 and 32 V/V can be configured. Refer to **Appendix D.**"Setup Conditions", for additional information.

When the momentary **READ** push button switch is pressed, the microcontroller reads the DIP switch configuration through the I/O ports. The controller determines the proper command and data bytes to be transmitted to the PGAs and the transmits a 16 or 32-bit word through the Serial Peripheral Interface (SPI[™]) port.

When the momentary **MCLR** push button switch is pressed, the microcontroller Master Clear is activated. This resets the microcontroller to a known initial state.

The ICSP connector provides the capability of programming the PIC16F676 from a PC. This requires additional hardware, such as MPLAB[®] ICD 2.

The two PGAs are cascaded, while the signal output of the MCP6S26 is directly connected to the analog input of the MCP6S21. This configuration outputs a maximum signal gain of 1024 V/V.

The digital lines of the PGA are daisy chained. The MCP6S26 has a Serial-Out (SO) line that can be used to serially program another device. Therefore, the SO line is connected to the Serial-In (SI) line of the MCP6S21. If the MCP6S26 is removed from the socket, the MCP6S21 cannot be programmed.

The MCP6S2X family of PGAs has a reference voltage input pin to offset the output signal. There are three reference voltage options on the board: 2.5V, adjustable reference voltage (0V to 5V) and ground. These options can be selected using the on-board jumper (JP1).

A prototype area is available for user circuit interface. The inputs, outputs and reference voltage traces of the PGAs conveniently pass near the prototype area for ease of connection. Test point connectors are available to interface with external circuits. The signals V_{IN_0} , V_{IN_1} , V_{OUT_1} and V_{OUT_2} can use SMA connectors that slide horizontally onto the board. 50 Ω termination resistors can be added to V_{IN_0} and V_{IN_1} . Refer to **Appendix A.**"Schematic and Board Layouts" and **Appendix D.**"Setup Conditions", for additional information.

1.3 HOW IT IS USED

1.3.1 Application Procedure - Stand-Alone Mode

- 1. Apply a 2.5V to 5.5V supply voltage to the V_{DD} and ground (GND) terminals of J1. Place the V_{DD} SELECT jumper (JP2) at the bottom (nearest J1).
 - **Note:** If jumper JP2 is incorrectly placed, there may be a conflict between power supplies.

For additional information on powering-up the MCP6S2X Evaluation Board (Rev. 4), refer to **Section 1.4.2** "**Applying Power**". During power-up, the MCP6S2X PGA's default settings are Channel 0 (CH0) and gain = 1 V/V.

- **Note:** Do <u>**NOT**</u> use the ICSP connector while in this mode (disconnect the cable). The results may be unpredictable and damage might occur due to conflicting voltage sources.
- Connect a voltage-measuring device (such as an oscilloscope) to V_{OUT_1} for the MCP6S26 and/or V_{OUT_2} for the MCP6S21.
- Select the desired reference voltage using JP1. If the adjustable reference voltage is selected, adjust this voltage using the potentiometer (ADJ_V_{REF}). A test point is available to measure the reference voltage. Refer to Section 1.4.5 "Reference Voltage" for additional information.
 - **Note:** There are soldering pads available across each input terminal for termination resistors (R_4 and R_5). If these resistors (e.g., 50 Ω) are needed for your application, solder them across the pads.
- 4. Apply the input signal source at V_{IN_0} and/or V_{IN_1} . V_{IN_0} is connected to Channel 0 and V_{IN_1} is connected to Channel 1 of the MCP6S26 (refer to **Section 1.4.4 "Analog Interface"**). Make sure that the input signal range is at the proper level to avoid railing the amplifier output when the signal is gained. Refer to **Section 1.4.5 "Reference Voltage**" for additional information.
- Refer to the Table 1-1 and select the desired gain, channel or shutdown using the on-board DIP switch. Press and release the **READ** push button switch to program the PGA and notice the change in the output voltage. Refer to Section 1.4.6 "Programming The PGA" for further explanation.

Register	$\begin{array}{c} MCP6S26\\ MSB \rightarrow LSB \end{array}$	$\begin{array}{c} \text{MCP6S21} \\ \text{MSB} \rightarrow \text{LSB} \end{array}$
Gain 1	00000	01000
Gain 2	00001	01001
Gain 4	00010	01010
Gain 5	00011	01011
Gain 8	00100	01100
Gain 10	00101	01101
Gain 16	00110	01110
Gain 32	00111	01111
Channel 0	10000	_
Channel 1	10001	_
Channel 2	10010	
Channel 3	10011	_
Channel 4	10100	_
Channel 5	10101	_
SHDN	11000	_
SHDN	—	11001
SHDN	11010	11010

TABLE 1-1: DIP SWITCH CONFIGURATION TABLE

1.3.2 Application Procedure - Program Mode

- 1. Place the V_{DD} SELECT jumper (JP2) at the top (away from J1). The MPLAB ICD 2 will provide 5V to the PGAs and to the microcontroller. Disconnect any external power supply from J1.
 - Note: The ICSP[™] connector can only be used to program the PIC16F676. In order to debug the firmware, use the MPLAB ICD 2 header. Refer to the MPLAB ICD 2 Header Installation Information (DS51292) for more information.
- Configure the MPLAB ICD 2 to provide power to the evaluation board through the ICSP connector. This is accomplished by changing the MPLAB ICD 2 configuration in MPLAB IDE. The MPLAB ICD 2 needs to be powered by an external power source.
- 3. Connect the MPLAB ICD 2 to the ICSP connector and update the PIC16F676 firmware from a PC using MPLAB ICD 2.
 - **Note:** Do not change either of the manual push button switches (**MCLR** and **READ**) while debugging the firmware. The results of this action would be unpredictable, and may cause damage due to conflicting voltage sources.

1.4 HOW IT WORKS

1.4.1 PGA Functions

The PGA has an internal precision operational amplifier in a non-inverting configuration. The gain of this operational amplifier is set using resistive ladders in the feedback loop. The resistor ratio is set using analog switches that are configured according to the instructions stored in the memory registers.

The MCP6S21/2/6/8 family of PGAs provide various input channel options: one, two, six or eight channel inputs, respectively. The non-inverting input of the internal precision operational amplifier is directly connected to the input channels through a multiplexer. The multiplexer is also configured according to the command stored in the memory registers. Figure 1-2 shows a block diagram of the MCP6S26 with six input channels. For the single-channel MCP6S21, the non-inverting input is directly connected to the input pin without a multiplexer.



FIGURE 1-2: The six-channel MCP6S26 PGA Block Diagram. The single-channel MCP6S21 does not have an input multiplexer.

^{4.} Follow steps 3 thru 5 in 1.3.1 "Application Procedure - Stand-Alone Mode".

1.4.2 Applying Power

The V_{DD} SELECT jumper (JP2) connects the power plane (V_{DD}) to either an external power supply (through J1) or to MPLAB ICD 2 (via the ICSP connector (J6)). It selects between two modes of operation:

- 1. **Stand-Alone Mode** The MCP6S2X Evaluation Board (Rev. 4) is configured using the on-board switches. Power is brought in to connector J1 from an external supply and the V_{DD} SELECT jumper selects J1. The external supply can be between 2.5V and 5.5V. When the PIC16F676 is in a valid operating voltage, the device will run the program stored in the device's program memory (the firmware).
- 2. **Program Mode** The MCP6S2X Evaluation Board (Rev. 4) is connected to the MPLAB ICD 2, which is connected to a PC. Power is brought in via the ICSP connector and the V_{DD} SELECT jumper selects the ICSP source. V_{DD} is 5.0V. The PIC16F676 firmware is reprogrammed by MPLAB IDE (application on PC).

1.4.3 Digital Interface

The memory registers are programmed using the SPI[™] interface from a PIC16F676 microcontroller. The digital interface uses a standard 3-wire SPI protocol with Chip Select (CS), Serial Clock (SCK) and Serial In (SI) lines. These lines are directly connected to the MCP6S26 and have pull-up resistors. These pull-up resistors provide noise immunity for the PGA from the PICmicro[®] microcontroller's I/O pins. The two PGAs are daisy chained with the SO pin from the MCP6S26 and connected to the SI pin of the MCP6S21. The SCK and CS lines are also connected to the MCP6S21.

In order to program the MCP6S21 through the daisy chain, the microcontroller pulls \overline{CS} low and sends the 32-bit word through the SPI line. The first 16-bit word contains the command and data bytes for the MCP6S21, while the next 16-bit word contains the command and data bytes for the MCP6S26. The second 16-bit word can be zeros or a NOP command. At the end of the 32nd clock cycle, the first 16-bit word is pushed out of the MCP6S26 (through the SO line) and into the MCP6S21 (through the SI line). When \overline{CS} toggles high, the bytes are latched in the registers. Instructions in the registers are then executed.

1.4.4 Analog Interface

The input channel 0 of the MCP6S26 is connected to V_{IN_0} . The input channels 1, 2 and 3 are connected to V_{IN_1} . Input channel 4 is connected to ground and input channel 5 is connected to the reference voltage. The user can connect two signal sources to channel 0 and channel 1 at V_{IN_0} and V_{IN_1} .

Note: There are soldering pads available across each input terminal for termination resistors (R_4 and R_5). If these resistors (e.g., 50 Ω) are needed for your application, solder them across the pads.

The output pin of the MCP6S26 is connected to V_{OUT_1} . This pin is also connected to Channel 0 of the MCP6S21. The MCP6S21 can be used to gain the signal from the MCP6S26 by gains of 1, 2, 4, 5, 8, 10, 16 and 32 V/V. If both PGAs are configured for a gain of 32 V/V, the total signal gain is 1024 V/V. This illustrates the fact that the user can cascade several PGAs to get higher gains. The output pin of the MCP6S21 is connected to V_{OUT_2} . The outputs of both PGAs are loaded with 10 k Ω resistors and 56 pF capacitors in parallel. These loads can be changed by the user.

Note: The signals V_{IN_0} , V_{IN_1} , V_{OUT_1} and V_{OUT_2} can be setup for test points (surface-mount on top) or for SMA connectors (slide onto board horizontally). Refer to **Appendix D, D.3** "**SMA Connectors**" for more information.

1.4.5 Reference Voltage

The MCP6S2X Evaluation Board (Rev. 4) has three reference-voltage settings, as shown in Figure 1-3. The MCP1525, a precision reference voltage device, is used to provide a 2.5V reference. The minimum supply voltage for this device is 2.7V. Therefore, this device will not operate when the evaluation board supply voltage (V_{DD}) is below 2.7V. An adjustable reference voltage (0V to 5V) is also available using a mechanical potentiometer. Since the reference voltage input of the PGA requires a low-impedance source, these reference voltages are buffered using the MCP6022, a 10 MHz operational amplifier. The PGA reference voltage input can also be connected to ground. All of these options can be selected using the on-board jumper connector JP1 (refer to **Appendix D.**"Setup Conditions" and D.5 "Reference Voltage Jumper **Positions**" for more information).



FIGURE 1-3: Simplified Reference Voltage Schematic.

The input and output of this PGA can swing rail-to-rail (V_{DD} and GND supply voltages). However, in order to keep linearity, the output voltage should not exceed the Maximum Output Voltage Swing, referred to in the electrical specifications of the MCP6S21/2/6/8 Data Sheet (DS21117). The reference voltage must be adjusted so that the maximum output would not exceed the specified limit.

The PGA output voltage, with respect to the input and reference voltages, can be determined using the following equation:

EQUATION 1-1:

	$V_{OUT_1} = G_{MCP6S26}(V_{IN_X} - V_{REF}) + V_{REF}$
	$V_{OUT_2} = G_{MCP6S26} \times G_{MCP6S21} (V_{IN_X} - V_{REF}) + V_{REF}$
Where:	$G_{MCP6S26}$ = gain of 1, 2, 4, 5, 8, 10, 16 or 32 V/V $G_{MCP6S21}$ = gain of 1, 2, 4, 5, 8, 10, 16 or 32 V/V V_{IN_X} = signal at the MCP6S26's selected channel V_{REF} = Reference Voltage at V_{REF} pin.

1.4.6 Programming The PGA

The DIP switch lines are connected to the five microcontroller I/O lines (RA5, RA2, RC0, RC1 and RC2) with pull-down resistors (Refer to Figure 1-1 and **Appendix A.** "Schematic and Board Layouts"). The extreme top switch is the Most Significant Bit (MSB) and the extreme bottom switch is the Least Significant Bit (LSB). Pushing the switches right corresponds to the '1', as shown on Table 1-1. Once the DIP switch is configured to the desired setting, the **READ** push-button switch must be pressed and released. When the button is released, the microcontroller reads the DIP switch settings and transmits the corresponding command and data bytes to the PGAs. The microcontroller remains in a loop to continuously monitor the **READ** push button switch. Refer to Table 1-1 for the settings.

NOTES:



Appendix A. Schematic and Board Layouts

A.1 INTRODUCTION

This appendix contains the schematic and printed circuit board (PCB) layout diagrams for the MCP6S2X Evaluation Board (Rev. 4).

A.1.1 Highlights

The MCP6S2X Evaluation Board (Rev. 4) is constructed using a four-layer PCB. The top and bottom layers are for components and traces. The second layer is the ground plane and the third layer is (V_{DD}) the power plane.

Diagrams included in this appendix include:

- Schematic
- Top Silk Screen Layer
- Top Metal Layer
- Ground Plane Layer
- · Power Plane Layer
- · Bottom Metal Layer
- Bottom Silk Screen Layer

Note: The bottom metal layer (A.7) is missing a connection between pin 8 of the PIC16F676 (U2 in A.2) and pin 6 of the DIP switch (DSW1 in A.2) and with the pull-down resistor (R11). These traces have been corrected prior to shipping by making a solder bridge between these pins.







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A.3 TOP SILK SCREEN



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A.4 TOP METAL LAYER



	0			
		000	0000	0
0	0000	0000000	00000000	0
		00000 00000	0	

A.5 GROUND PLANE LAYER

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A.6 POWER PLANE LAYER



A.7 BOTTOM METAL LAYER

